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- Inputs Are TTL-Voltage Compatible
- Flow-Through Architecture Optimizes
  PCB Layout
- Center-Pin V<sub>CC</sub> and GND Configurations Minimize High-Speed Switching Noise
- EPIC<sup>™</sup> (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

#### description

These devices contain a single 8-input NAND gate and perform the following Boolean functions in positive logic:

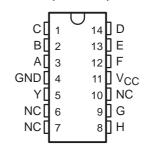
$$Y = \overline{A \cdot B \cdot C \cdot D \cdot E \cdot F \cdot G \cdot H}$$
 or  $Y = \overline{A + B + C + D + E + F + G + H}$ 

The 54ACT11030 is characterized for operation over the full military temperature range of -55°C to 125°C. The 74ACT11030 is characterized for operation from -40°C to 85°C.

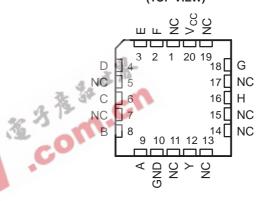
**FUNCTION TABLE** 

INPUTS A THRU H	OUTPUT
All inputs H	L
One or more inputs L	Н

#### 54ACT11030 ... J PACKAGE 74ACT11030 ... D OR N PACKAGE (TOP VIEW)

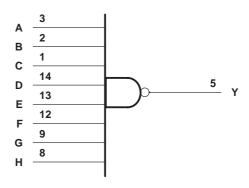


# 54ACT11030 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

#### logic diagram (positive logic)



# logic symbol†

٨	3	&	
A	2		
В	1		
С	14		_
D	13		5 Y
E	12		
F	9		
G	8		
Н			

† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.

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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V <sub>CC</sub>	$-0.5\;V$ to 6 $V$
Input voltage range, V <sub>I</sub> (see Note 1)	$\dots$ -0.5 V to V <sub>CC</sub> + 0.5 V
Output voltage range, V <sub>O</sub> (see Note 1)	$\dots$ -0.5 V to V <sub>CC</sub> + 0.5 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ )	$\dots \dots $
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> )	$\dots \dots $
Continuous output current, I <sub>O</sub> (V <sub>O</sub> = 0 to V <sub>CC</sub> )	±50 mA
Continuous current through V <sub>CC</sub> or GND	$\dots \dots $
Storage temperature range	65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

		54ACT	11030	74ACT	UNIT	
	4	MIN	MAX	MIN	MAX	UNIT
VCC	Supply voltage	4.5	5.5	4.5	5.5	V
VIH	High-level input voltage	2		2		V
$V_{IL}$	Low-level input voltage	A	0.8		0.8	V
VI	Input voltage	0	VCC	0	VCC	V
VO	Output voltage	0	VCC	0	VCC	V
IOH	High-level output current		-24		-24	mA
loL	Low-level output current		24		24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	0	10	ns/V
TA	Operating free-air temperature	-55	125	-40	85	°C



NOTE 1: The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS	VCC	T/	λ = 25°C	;	54ACT	11030	74ACT	11030	UNIT
PARAMETER	ARAMETER TEST CONDITIONS		MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
	- 50 A	4.5 V	4.4			4.4		4.4		
	ΙΟΗ = – 50 μΑ	5.5 V	5.4			5.4		5.4		
Vari	I <sub>OH</sub> = -24 mA	4.5 V	3.94			3.7		3.8		V
VOH	10H = -24 IIIA	5.5 V	4.94			4.7		4.8		v
	$I_{OH} = -50 \text{ mA}^{\dagger}$	5.5 V				3.85				
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V						3.85		
	Ι <sub>ΟL</sub> = 50 μΑ	4.5 V			0.1		0.1		0.1	
		5.5 V			0.1		0.1		0.1	
\/a:	I <sub>OL</sub> = 24 mA	4.5 V			0.36		0.5		0.44	V
VOL		5.5 V			0.36		0.5		0.44	
	$I_{OL} = 50 \text{ mA}^{\dagger}$	5.5 V					1.65			
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V			-				1.65	
lį	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1		±1	μΑ
lcc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V	31		4		80		40	μΑ
∆lCC <sup>‡</sup>	One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND	5.5 V	237	ş. "	0.9		1		1	mA
Ci	$V_I = V_{CC}$ or GND	5 V	-	3.5						pF

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 5 V $\pm$ 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T,	գ = 25°C	;	54ACT	11030	74ACT	11030	UNIT	
PARAMETER	(INPUT)	(INPUT) (O	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
<sup>t</sup> PLH	A thru H	V	1.5	5.4	8.1	1.5	8.8	1.5	8.5	no	
<sup>t</sup> PHL		ı	1.5	5.9	7.8	1.5	9.3	1.5	8.7	ns	

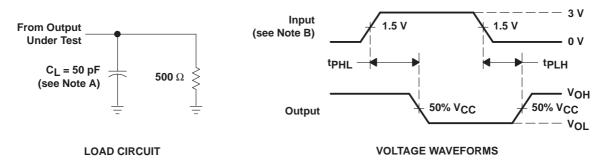
# operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

PARAMETER		TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per gate	$C_L = 50 \text{ pF}, \qquad f = 1 \text{ MHz}$	41	pF

<sup>‡</sup>This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or V<sub>CC</sub>.

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#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \ \Omega$ ,  $t_f = 3 \ ns$ ,  $t_f = 3 \ ns$ .
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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